



## **Media Release**

(all figures in US\$ unless otherwise stated)

# **SiTime Corp. Selects UTAC as the Assembly Partner for World's thinnest MEMS oscillator**

**Singapore, 19 March 2009** – United Test and Assembly Center Ltd (“UTAC”) and SiTime Corp. (Sunnyvale, California) (“SiTime”) announced today that SiTime has selected UTAC as their assembly partner for their MicroElectroMechanical Systems (“MEMS”) oscillator.

Leveraging on UTAC’s patent pending eXtremely-thin Leadframe Land Grid Array (“XLLGA”) package technology solution, it is touted as the world's thinnest MEMS oscillator at just 0.25 millimeters. This new device is being targeted at applications such as smart cards, ultra-thin cell phones, system-in-package modules, flash storage units and other multichip modules.

“Consumer demand for portable electronics is driving the development of smaller and thinner semiconductors,” said Piyush Sevalia, Vice-President of Marketing for SiTime. “We are pleased to take advantage of UTAC’s advanced XLLGA packaging solution for SiTime’s industry-leading MEMS and programmable analog technology to offer the thinnest, most cost effective, robust and reliable clock oscillator in the market, at the shortest lead times in the industry.”

“We’re proud that SiTime, a leading global MEMS-based silicon supplier, has chosen UTAC as their preferred assembly subcon provider,” said Udom Udompanyavit, President of UTAC’s Thailand operations. “UTAC has a large portfolio of JEDEC MSL1 green leadless Quad Flat No-lead (“QFN”) and Leadframe Land Grid Array (“LLGA”) packages. Our assembly and testing production capacity for leadless packages is over 10 million units per day.”

### **About United Test and Assembly Center Ltd (UTAC)**

United Test and Assembly Center Ltd (UTAC) is a leading independent provider of semiconductor assembly and testing services for a broad range of integrated circuits including memory, mixed-signal, logic and radio-frequency ICs. The Group offers a full range of package and test development, engineering and manufacturing services and solutions to a worldwide customer base, comprising leading integrated device manufacturers (IDMs), fables companies and wafer foundries. UTAC operates manufacturing facilities in Singapore, Thailand, Taiwan and China, in addition to its global network of sales offices in the United States, Europe, Japan, Korea, China and Singapore. For more information, please visit [www.utacgroup.com](http://www.utacgroup.com)

### **About SiTime**

SiTime Corporation develops MEMS-based silicon timing solutions. SiTime addresses the \$5B timing market with leadership products that are the smallest, thinnest, most robust, reliable, configurable, and offer the shortest lead times. The company’s solutions are the heartbeat of cutting-edge electronic products, such as fiber-to-the-home (FTTH) equipment, computing devices, graphics cards, disk drives, mobile phones and high capacity SIM cards. Headquartered in Sunnyvale, Calif., SiTime is privately owned and backed by leading venture capital firms. For more information, please visit [www.sitime.com](http://www.sitime.com)

For further information, please contact:

**UTAC**

Josephine Lim

Manager,

Corporate Communications

Email: [media@sg.utacgroup.com](mailto:media@sg.utacgroup.com)

Tel: (65) 6551-1511

Fax: (65) 6551-1521